

Half-Bridge IPM for Small Appliance Motor Drive Applications



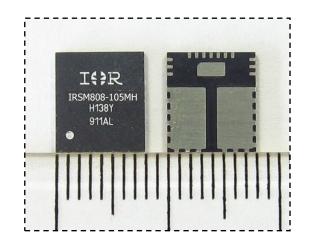
10A, 500V

Description

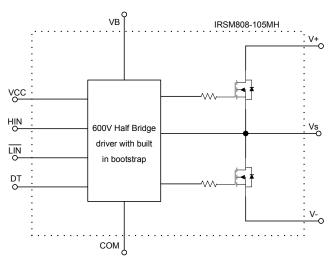
IRSM808-105MH is a 10A, 500V half-bridge module designed for advanced appliance motor drive applications such as energy efficient fans and pumps. IR's technology offers an extremely compact, high performance half-bridge topology in an isolated package. This advanced IPM offers a combination of IR's low R_{DS(on)} Trench FREDFET technology and the industry benchmark half-bridge high voltage, rugged driver in a small PQFN package. At only 8x9mm and featuring integrated bootstrap functionality, the compact footprint of this surface-mount package makes it suitable for applications that are space-constrained. IRSM808-105MH functions without a heat sink.

Features

- Integrated gate drivers and bootstrap functionality
- Suitable for sinusoidal modulation applications
- Low R_{DS(on)} Trench FREDFET
- Under-voltage lockout for both channels
- Matched propagation delay for all channels
- · Optimized dV/dt for loss and EMI trade offs
- 3.3V input logic compatible
- · Active high HIN and active low LIN
- Motor Power range 80-200W
- Isolation 1500V_{RMS} min
- ROHS compliant



Internal Electrical Schematic



Ordering Information

www.irf.com

Orderable Part Number	Package Type	Form	Quantity	
IRSM808-105MH	PQFN 8x9mm	Tray	1300	
IRSM808-105MHTR	PQFN 8x9mm	Tape and Reel	2000	

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Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the module may occur. These are not tested at manufacturing. All voltage parameters are absolute voltages referenced to V_{SS} unless otherwise stated in the table. The thermal resistance rating is measured under board mounted and still air conditions.

Symbol	Description	Min	Max	Unit
BV _{DSS}	MOSFET Blocking Voltage		500	V
lo	Output DC Current per MOSFET @ T _C =25°C		10	Α
P _d	Power dissipation per MOSFET @ T _C =100°C		-	W
T _J (MOSFET & IC)	T & IC) Maximum Operating Junction Temperature		150	°C
T _L	Lead temperature (soldering 30 seconds)		260	°C
Ts	Storage Temperature Range	-40	150	°C
V _B	High side floating supply voltage	-0.3	VS + 20	V
Vs	High side floating supply offset voltage	VB - 20	VB +0.3	V
V _{CC}	Low Side fixed supply voltage	-0.3	20	V
V _{IN}	Logic input voltage LIN, HIN	-0.3	VCC+0.3	V
V _{ISO}	Isolation voltage (1min) (Note2)		1500	V _{RMS}

Note1: Calculated based on maximum junction temperature. Bond wires current limit is 3.5A. Note2: Characterized, non tested at manufacturing

Reccomended Operating Conditions

Symbol Description		Min	Тур	Max	Units	Conditions
V ⁺	Positive DC Bus Input Voltage			400	V	
V _{S1,2,3}	High Side Floating Supply Offset Voltage			400	V	
V _{B1,2,3}	High Side Floating Supply Voltage	V _S +12		V _S +20	V	
V _{CC}	Low Side and Logic Supply Voltage	13.5		16.5	V	
V _{IN}	Logic Input Voltage			V _{cc}	V	
Fp	PWM Carrier Frequency			20	kHz	

For proper operation the module should be used within the recommended conditions. All voltages are absolute referenced to COM. The V_S offset is tested with all supplies biased at 15V differential.

Note 3: Logic operational for V_s from COM-8V to COM+500V. Logic state held for V_s from COM-8V to COM-V_{BS}.

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Static Electrical Characteristics

 $V_{BIAS} \ (V_{CC}, \ V_{BS}) = 15 V, \ T_J = 25 ^{o}C, \ unless \ otherwise \ specified. \ The \ V_{IN}, \ and \ I_{IN} \ parameters \ are \ referenced \ to \ COM$

Symbol	Description	Min	Тур	Max	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage				V	T _J =25°C, I _{LK} =3mA
I _{LKH}	Leakage Current of High Side FET's in Parallel		15		μA	T _J =25°C, V _{DS} =500V
I _{LKL}	Leakage Current of Low Side FET's in Parallel Plus Gate Drive IC	-	20		μA	T _J =25°C, V _{DS} =500V
_		-	0.58	0.8		T _J =25°C, V _{CC} =10V, Id = 6A
R _{DS(ON)}	Drain to Source ON Resistance	-	1.60		Ω	T _J =150°C, V _{CC} =10V, Id = 6A (Note 4)
V_{SD}	Diode Forward Voltage		0.85		V	T _J =25°C, V _{CC} =10V, Id = 6A
V _{HIN/LIN}	Logic "1" input voltage for HIN & "0" for LIN				V	
V _{HIN/LIN}	Logic "0" input voltage for HIN & "1" for LIN			0.8	V	
$V_{\text{CCUV+},}$ $V_{\text{BSUV+}}$	V _{CC} and V _{BS} Supply Under-Voltage, Positive Going Threshold	8	8.9	9.8	V	
V_{CCUV-}, V_{BSUV-}	V _{CC} and V _{BS} supply Under-Voltage, Negative Going Threshold	7.4	8.2	9.0	V	
$V_{\text{CCUVH}}, V_{\text{BSUVH}}$	V _{CC} and V _{BS} Supply Under-Voltage Lock- Out Hysteresis		0.7		V	
I_{QBS}	Quiescent V _{BS} Supply Current V _{IN} =0V		45	70	μΑ	
I _{QCC}	Quiescent V _{CC} Supply Current V _{IN} =0V		1100	1800	μΑ	
I _{HIN+}	Input Bias Current V _{IN} =4V		5	20	μΑ	
I _{LIN-}	N- Input Bias Current V _{IN} =0V		1	2	μA	
R _{BR} Internal Bootstrap Equivalent Resistor Value			200		Ω	T _J =25°C

Note 4: Characterized, not tested at manufacturing

MOSFET Avalanche Characteristics

Symbol Description		Min	Тур	Max	Units	Conditions
EAS	Single Pulse Avalanche Energy		216		mJ	T _J =25°C, L=3mH, VDD=100V, IAS=12A, TO-220 package.

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS})=15V, TJ=25°C, unless otherwise specified. Driver only timing unless otherwise specified.

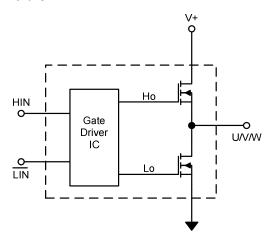
Symbol	Description		Тур	Max	Units	Conditions
T _{ON}	Input to Output Propagation Turn-On Delay Time		0.8	1.3	μs	I _D =1mA, V ⁺ =50V
T _{OFF}	Input to Output Propagation Turn-Off Delay Time		0.8	1.3	μs	Gate Driver; V _{LIN} =0 & V _{HIN} =5V
DT	Built-in Deadtime	0.9	1.3		μs	with no external deadtime
T _{FIL,IN}	Input Filter Time (HIN, LIN)		300		ns	



Thermal and Mechanical Characteristics

Symbol Description		Min	Тур	Max	Units	Conditions
R _{th(J-B)}	Thermal resistance, junction to mounting pad, each MOSFET		0.9		°C/W	Standard reflow-solder process
R _{th(J-A)}	Thermal resistance, junction to ambient, each MOSFET		TBD		°C/W	

Input-Output Logic Level Table



HIN	LIN	U,V,W
HI	HI	V+
LO	LO	0
HI	LO	**
LO	HI	*

^{*} V+ if motor current is flowing into VS, 0 if current is flowing out of VS into the motor winding ** Shoot-through condition



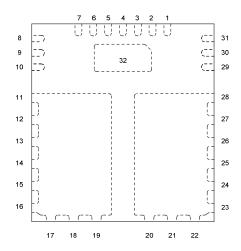
Target Qualification†

Qualifica	tion Level	Industrial ^{††} (per JEDEC JESD 47)
Moisture Sensitivity Level		MSL3 ^{†††} (per IPC/JEDEC J-STD-020)
ESD	Human Body Model	Class 1C (per JEDEC standard ANSI/ESDA/JEDEC JS-001)
E3D	Machine Model	Class A (per EIA/JEDEC standard JESD22-A115)
RoHS Co	ompliant	Yes

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- †† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- ††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

Module Pin-Out Description

Pin	Name	Description		
1, 4, 7, 32	COM	Low Side Gate Drive Return		
2	VCC	15V Gate Drive Supply		
3	HIN	Logic Input for High Side (Active High)		
5	LIN Logic Input for Low Side (Active Low)			
6	DT	Dead time		
8, 9, 10	V-	Low Side Source Connection		
11 – 19	VS	Phase Output		
20 – 28	V+	DC Bus		
29 – 30	VS	Phase Output (-ve Bootstrap Cap Connection)		
31	VB	High Side Floating Supply (+ve Bootstrap Cap Connection)		

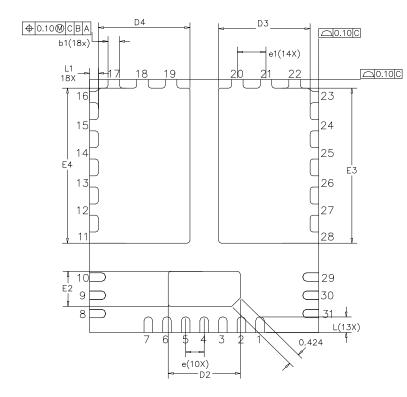


Exposed pad (Pin 32) has to be connected to COM for better electrical performance

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Package Outline IRSM808-105MH (Bottom View), 1 of 2

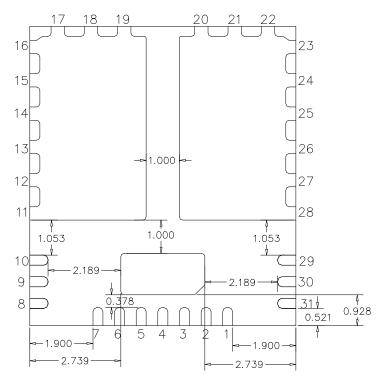


301	DIMENSIONS IN						
SYMBOL	MILLIMETER						
	MIN.	NOM.	MAX.				
Α	0.800	0.900	1.000				
A1	0.000		0.050				
А3	0.2	203 REF					
b	0.250	0.300	0.350				
b1	0.350	0.400	0.450				
D	7.900	8.000	8.100				
Е	8.900	9.000	9.100				
D2	2.472	2.522	2.572				
E2	1.197	1.247	1.297				
D3	3.147	3.197	3.247				
E3	5.472	5.522	5.572				
D4	3.147	3.197	3.247				
E4	5.472	5.522	5.572				
е	0.0	650 BS	C				
e1	1.0	000 BS	0				
e2	1.403 BSC						
еЗ	2.318 BSC						
L	0.500 0.550 0.60						
L1	0.253	0.303	0.353				

Dimensions in mm



Package Outline IRSM808-105MH (Bottom View), 2 of 2

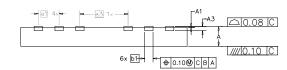


Dimensions in mm

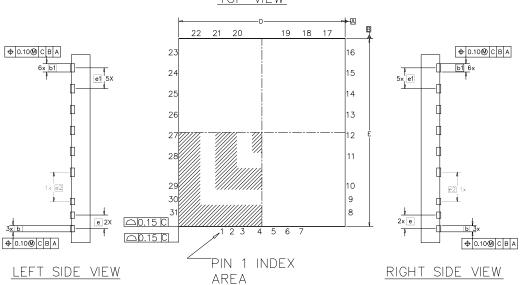


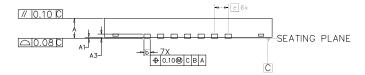
Package Outline IRSM808-105MH (Top & Side View)

BACK SIDE VIEW



TOP VIEW





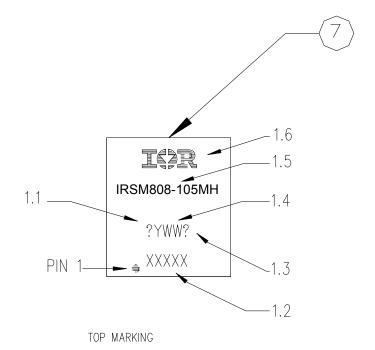
FRONT SIDE VIEW

7	DIMENSIONS				E2	1.197	1.247	1.297	
SYMBOL	M	IN MILLIMETER			D3	3.147	3.197	3.247	
S			-		F3	5.472	5.522	5.572	
	MIN.	NOM.	MAX.						
Α	0.800	0.900	1.000	i	D4	3.147	3.197	3.247	
		0.500		l	F4	5.472	5.522	5.572	
A1	0.000		0.050						
А3	0.	203 REI	-	İ	e	0.650 BSC			
				1	e1	1.000 BSC			
ь	0.250	0.300	0.350		-	1.000 B3C			
b1	0.350	0.400	0.450		e2	1.403 BSC		С	
D	7.900	8.000	8.100		e3	2.318 BSC			
Е	8.900	9.000	9.100	•	L	0.500 0.550 0.		0.600	
D2	2.472	2.522	2.572	•	L1	0.253	0.303	0.353	

Dimensions in mm



Top Marking



- NOTES, MARKING:
 1.1) SITE CODE: X
 1.2) LAST 4 CHARACTER OF SPN/NANA CODE: XXXX
 1.3) LEADFREE INDICATOR: P
 1.4) DATE CODE: YWW
 1.5) PART NUMBER: IRSM607-105MH
 1.6) IR LOCO

- 1.6) IR LOGO 1.7) MEDIUM:
- 1.7.1) TOP: LASER
- 1.7.2) BOTTOM: NONE



Typical Application Connection IRS808-105MH

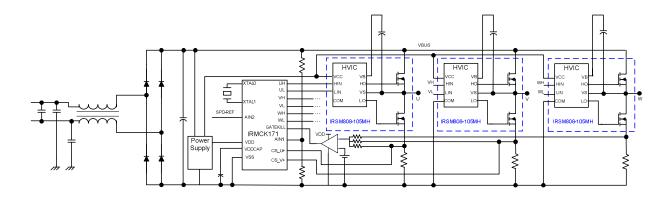
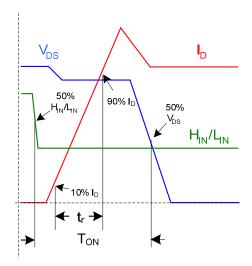


Figure 1: Typical Application Connection

- Bus capacitors should be mounted as close to the module bus terminals as possible to reduce ringing and EMI problems. Additional high frequency ceramic capacitor mounted close to the module pins will further improve performance.
- 2. In order to provide a good decoupling between VCC-VSS abd VB-VS terminals, the capacitors shown connected at these terminals should be located very close to the module pins. Additional high frequency capacitors, typically 0.1uF, are recommended.
- 3. Value of the boot-strap capacitors depends upon the switching frequency. Their selection should be made based on IR Design tip DT04-4 or application note AN-1044.





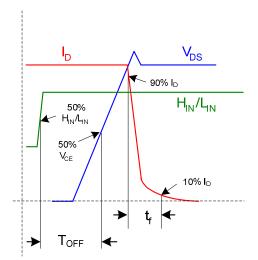


Figure 3a. Input to Output propagation turn-on delay time.

Figure 3b. Input to Output propagation turn-off delay time

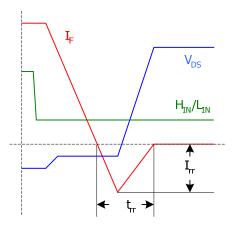


Figure 3c. Diode Reverse Recovery





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